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ESI to Participate in the Ninth Annual CEO Investor Summit 2017

PORTLAND, Ore., June 28, 2017 (GLOBE NEWSWIRE) -- Electro Scientific Industries, Inc. (NASDAQ:ESIO), an innovator in laser-based manufacturing solutions for the micro-machining industry, today announced that the Company's management will participate in the Ninth Annual CEO Investor Summit 2017, Wednesday July 12, 2017 in San Francisco, California.

About the 9th Annual CEO Summit

The CEO Summit is an accredited investor and publishing research analyst event that is held concurrently with SEMICON West and Intersolar 2017 in San Francisco. The event is hosted by executive management from participating companies and will feature a round-robin format consisting of small group meetings, each 30 minutes in duration.

The CEO Investor Summit is by invitation only and is open to accredited investors and publishing research analysts. Last day for registration is July 7, 2017.

RSVP Contacts for CEO Summit 2017

To RSVP for the CEO Summit, please contact either of the Summit's co-chairs.

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About ESI

ESI's integrated solutions allow industrial designers and process engineers to control the power of laser light to transform materials in ways that differentiate their consumer electronics, wearable devices, semiconductor circuits and high-precision components for market advantage. ESI's laser-based manufacturing solutions feature the micro-machining industry's highest precision and speed, and target the lowest total cost of ownership. ESI is headquartered in Portland, Ore., with global operations from the Pacific Northwest to the Pacific Rim. More information is available at www.esi.com.

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Source: Electro Scientific Industries, Inc.

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